

SPECIFICATION FOR TFT MODULE

MODULE NO: AFS320240TG-2.3-A200001 REVISION NO: 00

(Customer's Approval:							
_								
L		SIGNATURE	DATE					
L	PREPARED BY (RD ENGINEER)							
	CHECKED BY							
Г	APPROVED BY							

DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
00	Dec-5-2011	First Issue	Ylh

CONTENTS

1. Features & Mechanical specifications	1
2. Dimensional Outline	2
3. Block Diagram	3
4. Pin Description	4
5. Absolute Maximum Ratings	7
6. Electrical Characteristics	7
7. Backlight Specification	7
8. Electro-Optical Characteristics	8
9. Instruction Description	10
10. AC Characteristics	11
11. Quality Specification	16

1. Features & Mechanical Specifications

Item	Contents LCD	Unit
LCD Type	TFT / Transmissive / Normal White	
Viewing direction	6 O'clock	
Backlight	4 Chip White LED in serial	
Interface	8080-8/bit parallel bus interface	
Driver IC	HX8368-A03	
Outline Dimension	$50.9(W) \times 45.8(H) \times 2.3(T)$	mm
Glass area (W×H×T)	49.752 ×41.664× 1.0	mm
Active area (W×H)	46.752 × 35.064	mm
Number of Dots	320(RGB) × 240	
Dot pitch (W×H)	0.1461 × 0.1461	mm
Pixel pitch (W×H)	0.0487×0.0487	mm
Operating Temperature	-20 ∼ +70	$^{\circ}$ C
Storage temperature	-30 ∼ +80	°C

2. Dimensional Outline

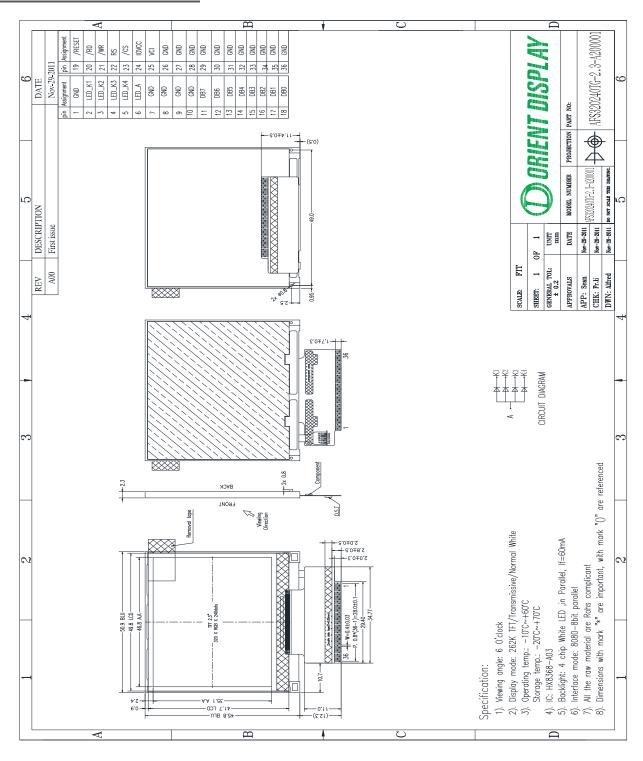


Figure 1. Dimensional outline

3. Block Diagram

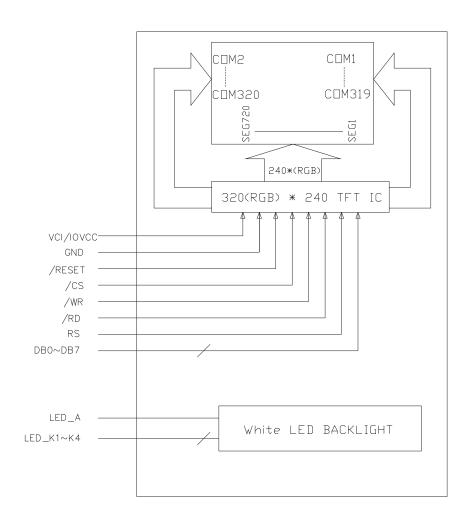


Figure 2. Block diagram

4. Pin Description

PIN No.	SYMBOL	Function
1	GND	Ground
2~5	LED_K1~K4	Backlight LED Cathode
6	LED_A	Backlight LED Anode
7~10	GND	Ground
11~18	DB7~DB0	Data Bus
19	/RESET	Reset pin. (Active Low)
20	/RD	Read signal input pin. (Active Low)
21	/WR	Write signal input pin. (Active Low)
22	RS	Data or command select pin. "H": Date, "L": Command.
23	/CS	Chip Select input pin. (Active Low)
24	IOVCC	Power supply for I/O
25	VCI	Power supply for Analog
26~36	GND	Ground

5. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply Voltage range	VCI	-0.3 to +4.6	V
Operating Temperature range	TOP	-20 to +70	°C
Storage Temperature range	TST	-30 to +80	$^{\circ}$ C

6. Electrical Characteristics

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VCI	2.5	-	3.3	V

7. Backlight Characteristics

White LED \times 3 (Ta = 25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF = 60 mA	-	3.2	-	V
Uniformity	∆Bp	-	80	-	-	%
Luminance for LCD	Lv	IF = 60 mA	3200	-	ı	cd/m ²

8. Electro-Optical Characteristics

Item	Symbol	Sp	ecificat	ion	Unit	Remark
item	Syllibol	Min	Тур	Max	Oilit	
TFT gate on voltage	VGH	-	15	-	٧	
TFT gate off voltage	VGL	-	-10	-	٧	

Note:

- (1) Vcom must be adjusted to optimize display quality: cross talk, contrast ratio and etc.
- (2) VGH is TFT gate operating voltage
- (3) VGL is TFT gate operating voltage

The storage capacitance structure of this product is Cst(Storage on Common). The low voltage level of VGL signal must be fluctuated with same phase as Vcom, in case of Storage on Gate structure.

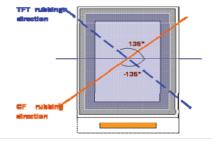
(4) Environmental condition : 25℃.

EWV Polarizer:Ta=25°C

							Folarizer		
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	
		θТ		60	70	-			
\		θВ	CR≧10	50	60	-	D	Note 2	
View Angles		θL	CK=10	60	70	-	Degree	Note 2	
		θR		60	70	-	1		
Contrast Ratio)	CR	θ=0°	400	500	-	-	Note1 Note3	
Response Time		T _{ON}	25℃	-	20	30	ms	Note1	
		T _{OFF}						Note4	
	White	х		0.255	0.305	0.355			
	VVIIILE	у		0.311	0.361	0.411			
	Red	x		0.571	0.621	0.671			
Chromaticity		у	C-Light	0.269	0.319	0.369		Note5	
Cilionaticity	Green	x	C-Light	0.252	0.302	0.352		Note1	
	Green	у		0.515	0.565	0.615			
	Blue	x		0.087	0.137	0.187			
	Dide	у		0.114	0.164	0.214			
NTSC		-	-	45	50	-	%	Note 5	
Transmittance)	Т	-	6.0	6.3	-	%	Note1	

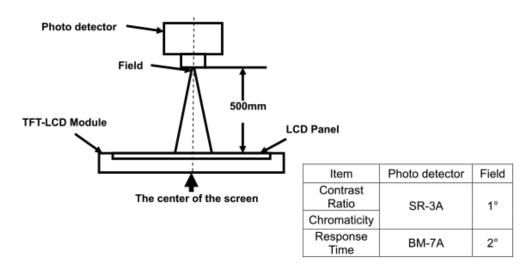
Test Conditions:

- 1. The ambient temperature is 25° C.
- 2. The test systems refer to Note 1 and Note 2.
- 6.2 Rubbing Direction



Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system. viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

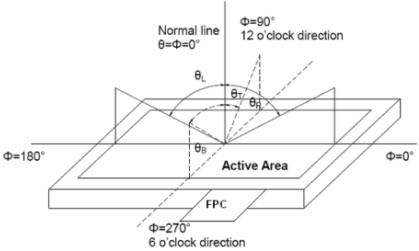


Fig. 1 Definition of viewing angle

Note 3: Definition of contrast ratio

 $\mbox{Contrast ratio (CR)} = \frac{\mbox{Luminance measured when LCD is on the "White" state}}{\mbox{Luminance measured when LCD is on the "Black" state}}$

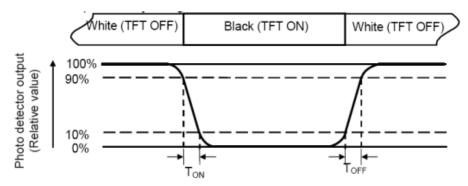
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

9. Instruction Description

OTP_INDEX	D7	D6	D5	D4	D3	D2	D1	D0	
0x00h	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	
0x01h	ID27	ID26	ID25	ID24	ID23	ID22	ID21	ID20	
0x02h	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30	
0x03h	VMF17	VMF16	VMF15	VMF14	VMF13	VMF12	VMF11	VMF10	
0x04h	VMF27	VMF26	VMF25	VMF24	VMF23	VMF22	VMF21	VMF20	
0x05h	VMF37	VMF36	VMF35	VMF34	VMF33	VMF32	VMF31	VMF30	
0x06h	VMH7	VMH6	VMH5	VMH4	VMH3	VMH2	VMH1	VMH0	
0x07h	VML7	VML6	VML5	VML4	VML3	VML2	VML1	VML0	
0x08h	Vaild_ID	SELF_DIA G	CLR_RAM	Valid_VML	Valid_VMH	Valid_VMF 3	Valid_VMF 2	1	
0x09h	Valid_panel	VPNL_EN B	DDVDH_T RI	SM_Panel	SS_Panel	GS_Panel	REV_Pane I	BGR_Panel	
0x0Ah			Hi	max internal	use (not ope	n)			
0x0Bh			Hi	max internal	use (not ope	n)			
0x0Ch				max internal					
0x0Dh				max internal					
0x0Eh				max internal					
0x0Fh				max internal					
0x10h				max internal		,			
0x11h				max internal					
0x12h				max internal					
0x13h				max internal					
0x14h				max internal					
0x15h				max internal					
0x16h				max internal					
0x17h					rnal use (not open)				
0x18h	ID47	ID46	ID45	ID44	ID43	ID42	ID41	ID40	
0x19h				max internal					
0x1Ah				max internal					
0x1Bh				max internal					
0x1Ch				max internal					
0x1Dh				max internal					
0x1Eh				max internal					
0x1Fh				max internal					
0x20h 0x21h				max internal					
0x21h 0x22h	Himax internal use (not open) Himax internal use (not open)								
0x22h	Valid_gam ma1 (no use) VRP0[5:0]								
0x24h	(no use) (no use) VRP1[5:0]								
0x25h	(no use) (no use) VRP2[5:0]								
0x26h	(no use)	(no use)			VRP3	3[5:0]			
0x27h	(no use) PRP0[6:0]								
0x28h	(no use)				RPR1[6:0]				
0x29h		VRP4[5:3]				PKP0[4:0]			
0x2Ah		VRP4[2:0]				PKP1[4:0]			
0x2Bh		VRP5[5:3]				PKP2[4:0]			
0x2Ch		VRP5[2:0]				PKP3[4:0]			
0x2Dh	(no use)	(no use)	(no use)			PKP4[4:0]			

		,						
0x2Eh	(no use)	(no use)			VRN0[5:0]			
0x2Fh	(no use)	(no use)			VRN1[5:0] VRN2[5:0]			
0x30h	(no use)	(no use)						
0x31h	(no use)	(no use)		VRN3[5:0]				
0x32h	(no use)				PRN0[6:0]			
0x33h	(no use)			,	PRN1[6:0]			
0x34h		VRN4[5:3]			PKN0[4:0]			
0x35h		VRN4[2:0]			PKN1[4:0]			
0x36h		VRN5[5:3]			PKN2[4:0]			
0x37h		VRN5[2:0]			PKN3[4:0]			
0x38h	(no use)	(no use)	(no use)		PKN4[4:0]			
0x39h		N1[1:0]	CGMN	NO[1:0]	CGMP1[1:0]	CGMP0[1:0]		
0x3Ah	Valid_gam ma2	(no use)			VRP0[5:0]			
0x3Bh	(no use)	(no use)			VRP1[5:0]			
0x3Ch	(no use)	(no use)			VRP2[5:0]			
0x3Dh	(no use)	(no use)			VRP3[5:0]			
0x3Eh	(no use)				PRP0[6:0]			
0x3Fh	(no use)				RPR1[6:0]			
0x40h		VRP4[5:3]			PKP0[4:0]			
0x41h		VRP4[2:0]			PKP1[4:0]			
0x42h		VRP5[5:3]			PKP2[4:0]			
0x43h		VRP5[2:0]			PKP3[4:0]			
0x44h	(no use)	(no use)	(no use)		PKP4[4:0]			
0x45h	(no use)	(no use)			VRN0[5:0]			
0x46h	(no use)	(no use)			VRN1[5:0]			
0x47h	(no use)	(no use)			VRN2[5:0]			
0x48h	(no use)	(no use)			VRN3[5:0]			
0x49h	(no use)				PRN0[6:0]			
0x4Ah	(no use)				PRN1[6:0]			
0x4Bh		VRN4[5:3]			PKN0[4:0]			
0x4Ch		VRN4[2:0]			PKN1[4:0]			
0x4Dh		VRN5[5:3]			PKN2[4:0]			
0x4Eh	1-5-2-1	VRN5[2:0]	No. Lucal	PKN3[4:0]				
0x4Fh 0x50h		(no use) N1[1:0]	(no use) CGMN	1014.01	PKN4[4:0]	CGMP0[1:0]		
	Valid_gam		CGIVIN	10[1:0]	CGMP1[1:0]	CGMPU[1:0]		
0x51h	ma3	(no use)			VRP0[5:0]			
0x52h	(no use)	(no use)			VRP1[5:0]			
0x53h	(no use)	(no use)			VRP2[5:0]			
0x54h	(no use)	(no use)			VRP3[5:0]			
0x55h	(no use)				PRP0[6:0]			
0x56h	(no use)	\/DD ::= 61	RPR1[6:0]					
0x57h		VRP4[5:3]	PKP0[4:0]					
0x58h		VRP4[2:0]	PKP1[4:0]					
0x59h		VRP5[5:3]		PKP2[4:0]				
0x5Ah	(VRP5[2:0]	PKP3[4:0]					
0x5Bh	(no use)	(no use)	(no use)					
0x5Ch	(no use)	(no use)		VRN0[5:0]				
0x5Dh	(no use)	(no use)		VRN1[5:0]				
		(no use)		VRN2[5:0]				
0x5Eh	(no use)							
0x5Fh	(no use)	(no use)			VRN3[5:0]			

0x62h		VRN4[5:3]			PKN0[4:0]		
0x63h		VRN4[2:0]		PKN1[4:0]			
0x64h		VRN5[5:3] PKN2[4:0]					
0x65h	VRN5[2:0]			PKN3[4:0]			
0x66h	(no use)	(no use)	(no use)		PKN4[4:0]		
0x67h	CGMN	N1[1:0]	CGMN				
0x68h	Valid_gam ma4	(no use)			VRP0[5:0]		
0x69h	(no use)	(no use)			VRP1[5:0]		
0x6Ah	(no use)	(no use)			VRP2[5:0]		
0x6Bh	(no use)	(no use)			VRP3[5:0]		
0x6Ch	(no use)				PRP0[6:0]		
0x6Dh	(no use)				RPR1[6:0]		
0x6Eh		VRP4[5:3]			PKP0[4:0]		
0x6Fh		VRP4[2:0]			PKP1[4:0]		
0x70h		VRP5[5:3]			PKP2[4:0]		
0x71h		VRP5[2:0]		PKP3[4:0]			
0x72h	(no use)	(no use)	(no use)	PKP4[4:0]			
0x73h	(no use)	(no use)		VRN0[5:0]			
0x74h	(no use)	(no use)		VRN1[5:0]			
0x75h	(no use)	(no use)			VRN2[5:0]		
0x76h	(no use)	(no use)			VRN3[5:0]		
0x77h	(no use)				PRN0[6:0]		
0x78h	(no use)			PRN1[6:0]			
0x79h		VRN4[5:3]		PKN0[4:0]			
0x7Ah		VRN4[2:0]		PKN1[4:0]			
0x7Bh		VRN5[5:3]		PKN2[4:0]			
0x7Ch		VRN5[2:0]		PKN3[4:0]			
0x7Dh	(no use)	(no use)	(no use)	PKN4[4:0]			
0x7Eh	CGMN	N1[1:0]	CGMN				
0x7Fh	Himax internal use (not open)						

10. AC Characteristics

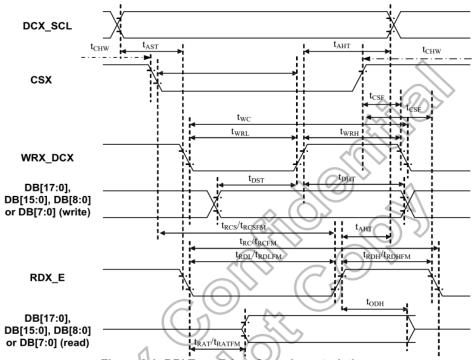


Figure 8.1: DBI Type-B interface characteristics

(VSSA=0V, IOVCC=1.65V to 3.3V, VCC=2.3V to 3.3V, VCI=2.3V to 3.3V, T_A = -30 to 70° C)

(VSSA-0V, IOVCC-1.65V to 5.5V, VCC-2.5V to 5.5V					<u> </u>		
Signal	Symbol	Parameter	Min.	Max.	Unit	Description	
DCX_SCL	t _{AST}	Address setup time	0	-	ns		
DOX_SCL	t _{AHT}	Address hold time (Write/Read)	10	-	113	-	
<	t _{CHW}	CSX "H" Pulse Width	0	-			
	t _{cs}	Chip Select setup time (Write)	15	-			
CSX	t _{RCS}	Chip Select setup time (Read ID)	45	-	ns	-	
	t _{RCSFM}	Chip Select setup time (Read FM)	355	-			
· ·	t _{CSF}	Chip Select Wait time (Write/Read)	10	-			
	t _{wc}	Write cycle	66	-			
WRX_DCX	t _{WRH}	Control pulse H duration	15	-	ns	-	
	t _{WRL}	Control pulse L duration	15	-			
	t _{RC}	Read cycle (ID)	160	-			
RDX_E(ID)	t _{RDH}	Control pulse H duration (ID)	90	-	ns	When read ID data	
_ ` ` ′	t _{RDL}	Control pulse L duration (ID)	45	-			
	t _{RCFM}	Read cycle (FM)	450	-		When read from frame	
RDX_E (FM)	t _{RDHFM}	Control pulse H duration (FM)	90	-	ns		
	t _{RDLFM}	Control pulse L duration (FM)	355	-		memory	
DB[17:0],	t _{DST}	Data setup time	10	-			
DB[17.0], DB[15:0],	t _{DHT}	Data hold time	10	-		For maximum CL=30pF	
DB[8:0], or	t _{RAT}	Read access time (ID)	-	40	ns	For minimum CL=8pF	
	t _{RATFM}	Read access time (FM)	-	340		For minimum CL=ope	
DB[7:0]	t _{ODH}	Output disable time	20	80			

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals. t_{WC} min is 100nS at 18-bit mode.

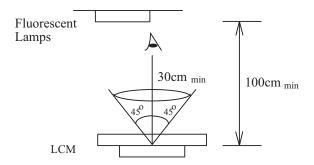
11.Quality Specifications

All The raw material are Rohs complicant.

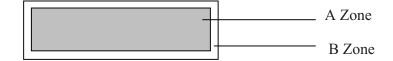
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is $45\,^{\circ}$ from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area

11.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

No.	Item	Criterion				
1	Short or open circuit	Not allow				
	LC leakage					
	Flickering	-				
	No display	-				
	Wrong viewing direction	-				
	Wrong Back-light	_				
2	Contrast defect		Refe	er to	approval san	nple
	Background color deviation	-				
3	Point defect, Black spot, dust (including Polarizer)	$\bigcirc \bigvee_{\bigotimes} Y$			Point Size	Acceptable Qty. Disregard
	(morwang reminder)	A		0	.10⊠⊠≤0.20	3
					.20⊠⊠≤0.25	2
	$\boxtimes = (X+Y)/2$			0	.25⊠⊠≤0.30	1
					⊠>0.30	0
			Uni	it:	mm	
4	Line defect,	→ w				
	G 1				Line	Acceptable Qty.
	Scratch	$\left \longleftrightarrow\right $	L		W 0.015≥W	Digragard
		L	3.0≥		0.013≥W 0.03≥W	Disregard
			2.0		0.05≥W	2
			1.0>	:L	0.1>W	1
					0.05⊠W	Applied as point defect
		Unit: mm				
5	Rainbow	Not more than two color changes across the viewing area.				

No	Item	Criterion
6	Chip Remark: X: Length direction Y: Short	Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		Acceptable criterion $\begin{array}{c cccc} X & Y & Z \\ \hline \leqslant 3 & \leqslant 2 & \leqslant t \\ \hline \text{shall not reach to ITO} \end{array}$
		Acceptable criterion $\frac{Y}{X} \downarrow \qquad \frac{X}{Z} \qquad \frac{Z}{Disregard} \qquad \leqslant 0.2 \qquad \leqslant t$
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

No.	Item	Criterion				
7	Segment pattern $W = Segment width$ $\boxtimes = (X+Y)/2$	(1) Pin hole				
8	Back-light	(1) The color of backlight should correspond its specification.				
9	(2) Not allow flickering Soldering (1) Not allow heavy dirty and solder ball on PCB.					
		(The size of dirty refer to point and dust defect)(2) Over 50% of lead should be soldered on Land.				
		Land				
10	50% lead					
		 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. 				
11*	PCB	(4) Not allow exposed copper wire inside the flat cable.(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.				

No	Item	Criterion
12	Protruded W: Terminal Width	Acceptable criteria: $Y \boxtimes 0.4$
13	TAB	1. Position $\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		2 FPC bonding strength test FPC P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.

11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80⊠C	48	
High temp. Operating	70⊠C	48	
Low temp. Storage	-30⊠C	48	No abnormalities
Low temp. Operating	-20⊠C	48	in functions
Humidity	60⊠C/ 90%RH	48	and appearance
Temp. Cycle	-30⊠C ⊠ 25⊠C ⊠ 80⊠C	10cycles	
	(60 min ⊠ 5 min ⊠ 60min)		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20±8\mathbb{K}C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280\(\tilde{L}C+10\(\tilde{L}C\)
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40\mathbb{X}C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Orient Disply LCDs and modules are not consumer products, but may be incorporated by OD's customers into consumer products or components thereof, OD does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of OD is limited to repair or replacement on the terms set forth below. OD will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between OD and the customer, OD will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with OD general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.

21